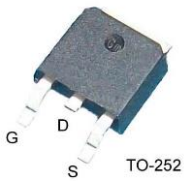
Features

- 60V, 25A
- $R_{DS(ON)}$ =32mΩ (Max.) @ V_{GS} = 10V, I_D = 10A
- 100% EAS Guaranteed
- Green Device Available
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

Application

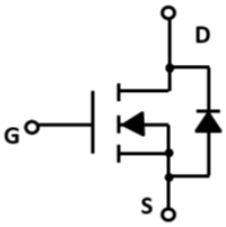
- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible Power Supply

Package



TO-252

SFD25N06BT



Absolute Maximum Ratings T_C=25℃ unless otherwise specified

Symbol	Parameter		Max.	Units
V_{DSS}	Drain-Source Voltage		60	V
V_{GSS}	Gate-Source Voltage		± 20	V
I_D	Continuous Drain Current	T_C = 25℃	25	A
		T_C = 100℃	17	A
I_{DM}	Pulsed Drain Current note1		48	A
P_D	Power Dissipation	T_C = 25℃	35	W
$R_{\theta JC}$	Thermal Resistance, Junction to Ambient		50	℃/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		3.5	℃/W
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +175	℃

*Drain current limited by maximum junction temperature

Electrical Characteristics T_C=25℃ unless otherwise specified

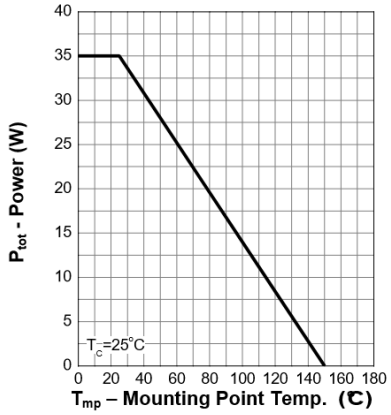
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 48V, V_{GS} = 0V	-	-	1	μA
I_{GSS}	Gate to Body Leakage Current	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	1.0	-	2.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance note2	V_{GS} = 10V, I_D = 15A	-	26	32	mΩ
		V_{GS} = 4.5V, I_D = 7A	-	31	40	
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 30V, V_{GS} = 0V, f = 1.0MHz	-	1058	-	pF
C_{oss}	Output Capacitance		-	42	-	pF
C_{rss}	Reverse Transfer Capacitance		-	35	-	pF
Q_g	Total Gate Charge(10V)	V_{DS} = 30V, I_D = 10A, V_{GS} = 10V	-	19	-	nC
Q_{gs}	Gate-Source Charge		-	5	-	nC
Q_{gd}	Gate-Drain(“Miller”) Charge		-	2.6	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 30V, I_D = 10A R_L= 3Ω, V_{GEN} = 10V R_G= 4.5Ω	-	7.4	-	ns
t_r	Turn-On Rise Time		-	26	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	17	-	ns
t_f	Turn-Off Fall Time		-	28	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	25	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0V, I_S =10A	-	-	1.3	V
trr	Body Diode Reverse Recovery Time	V_{GS} = 0V, I_F = 10A, di/dt =100A/μs	-	12.7	-	ns
Qrr	Body Diode Reverse Recovery Time Charge		-	2.8	-	nC

Notes:

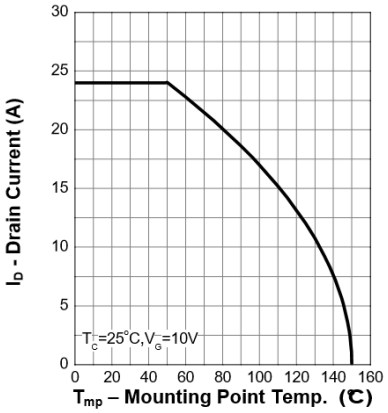
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%

Typical Performance Characteristics

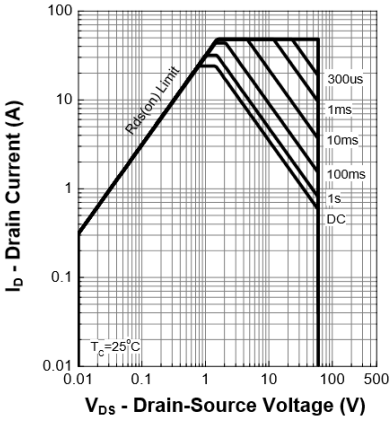
Power Capability



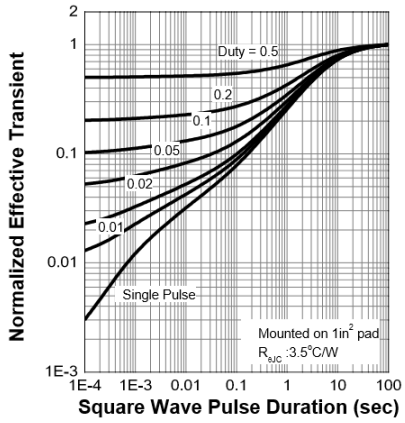
Current Capability



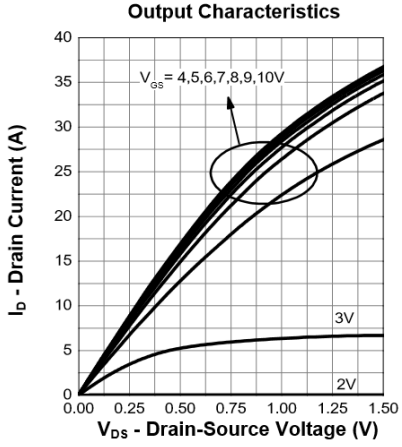
Safe Operating Area



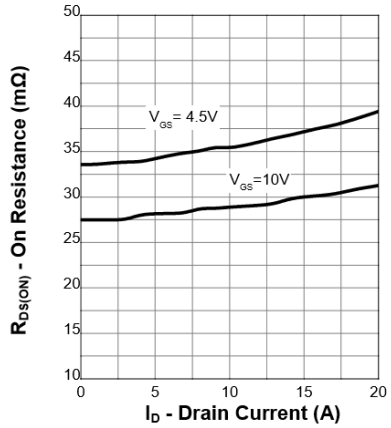
Transient Thermal Impedance



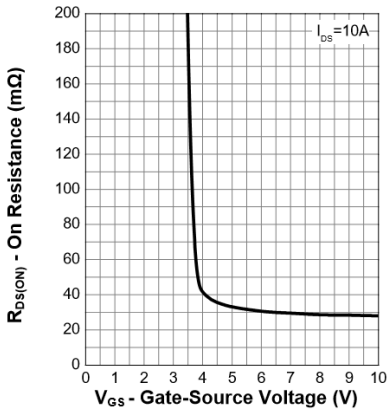
Output Characteristics



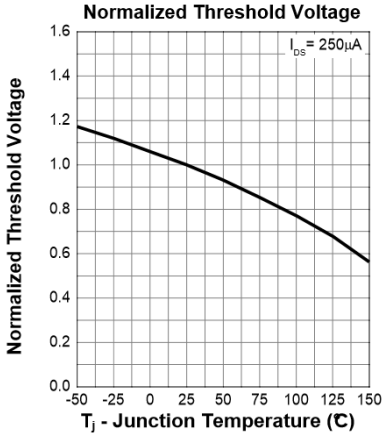
On Resistance



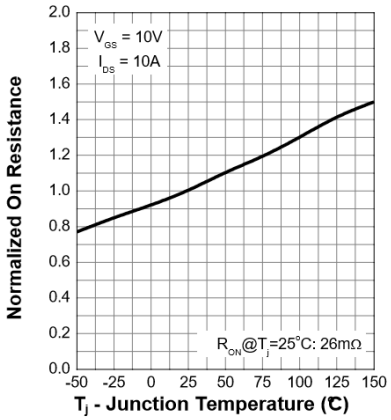
Transfer Characteristics



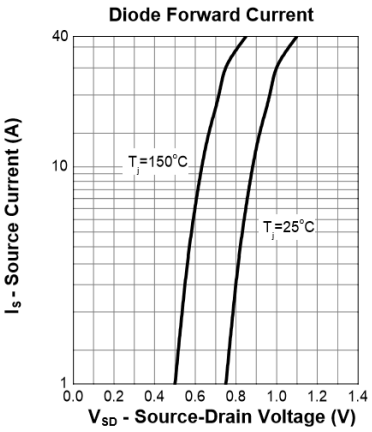
Normalized Threshold Voltage



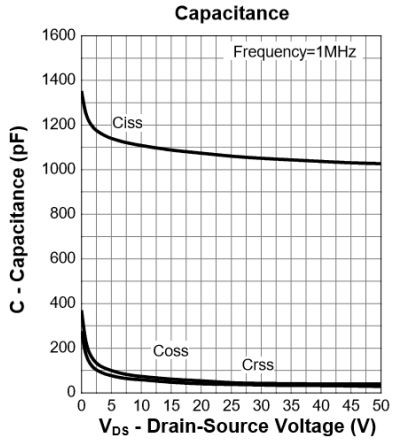
Normalized On Resistance



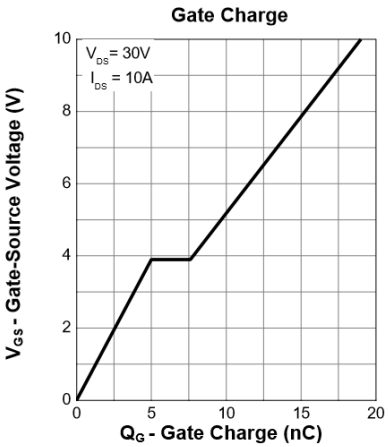
Diode Forward Current



Capacitance



Gate Charge



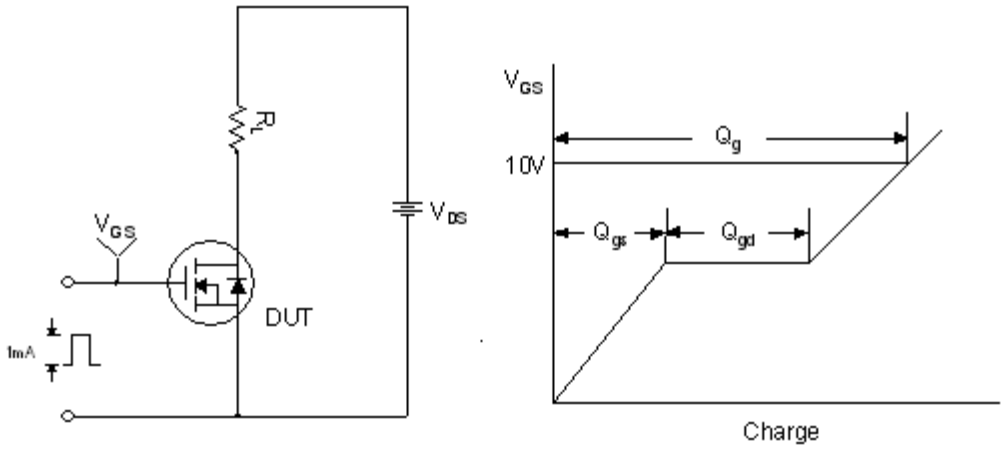


Figure 1. Gate Charge Test Circuit & Waveform

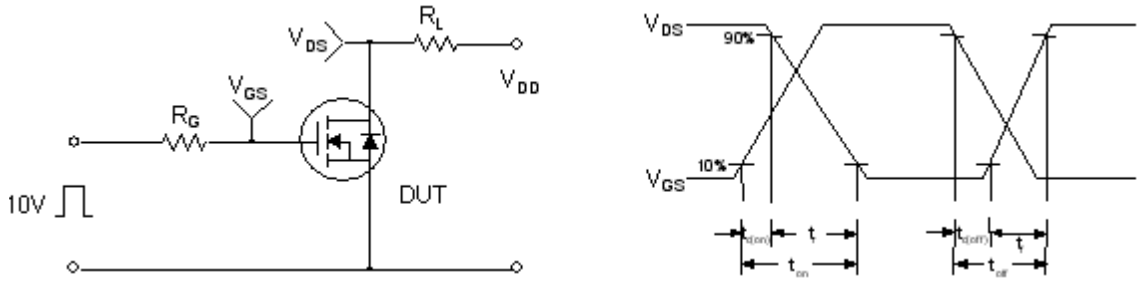


Figure 2. Resistive Switching Test Circuit & Waveforms

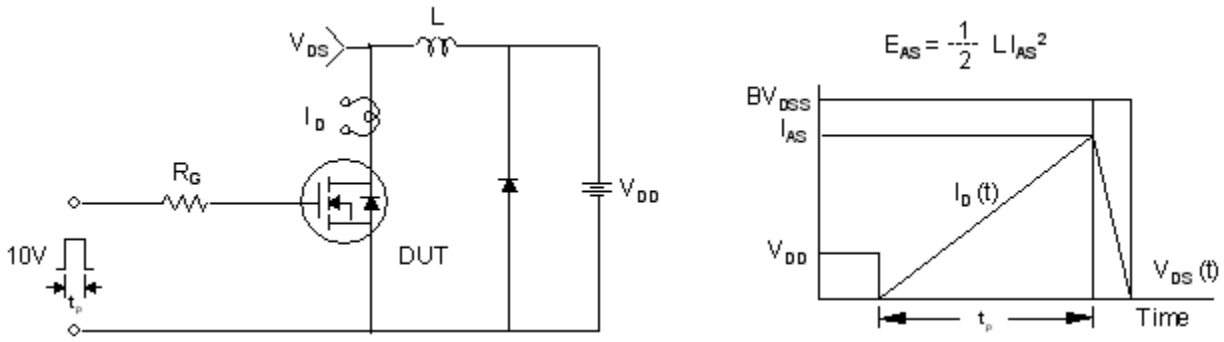


Figure 3. Unclamped Inductive Switching Test Circuit & Waveforms

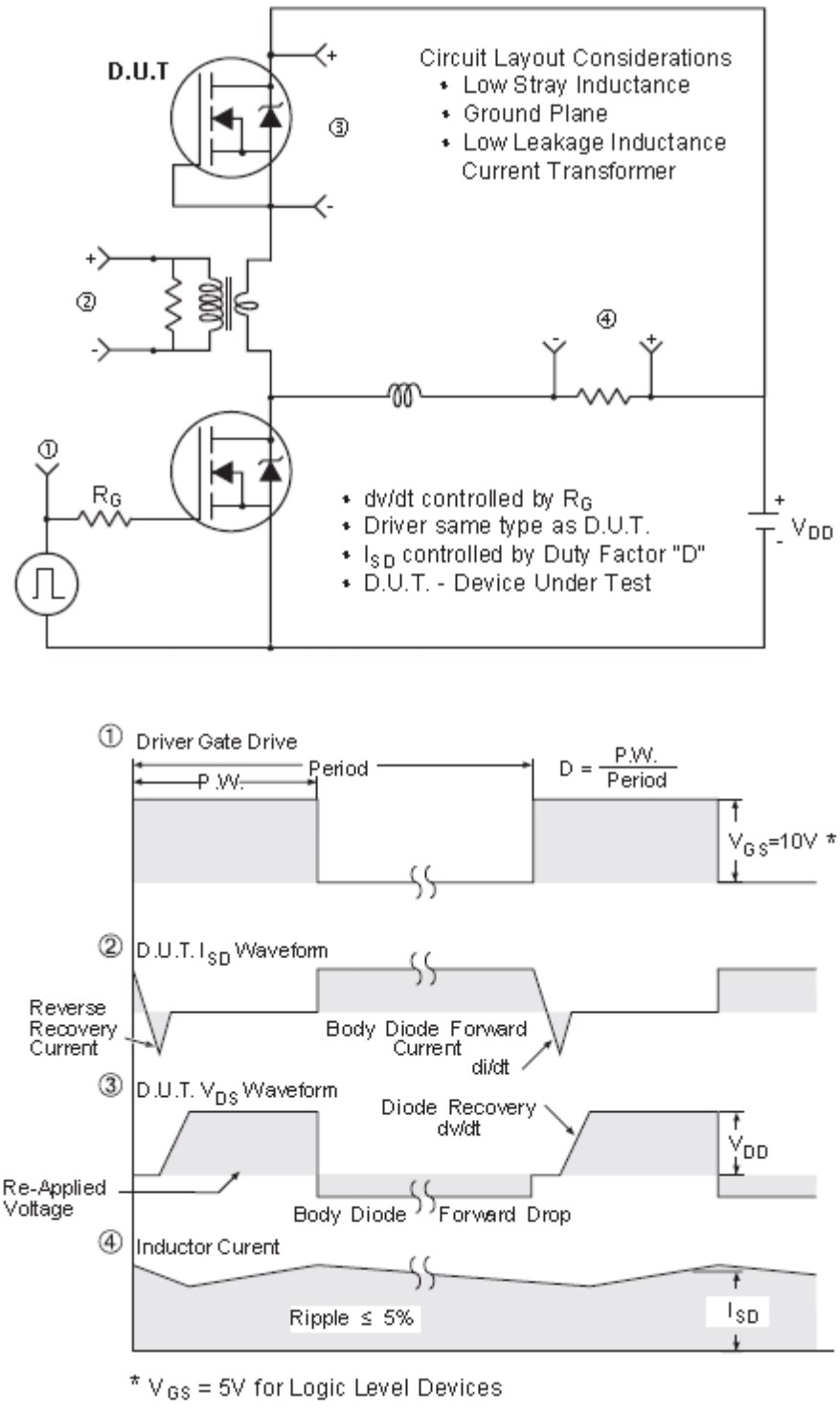
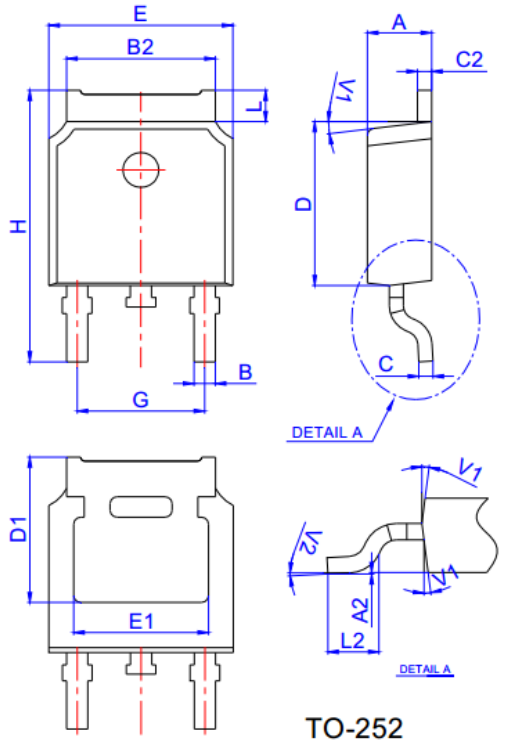


Figure 4. Peak Diode Recovery dv/dt Test Circuit & Waveforms (For N-channel)

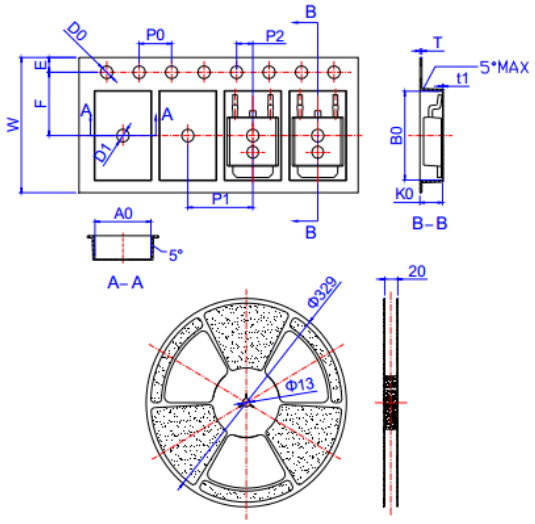
Package Mechanical Data



TO-252

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Specification-TO-252



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583

OUTLINE	REEL (PCS)	PER CARTON (PCS)	TAPE & REEL
TAPING	2,500	25,000	13inch

NOTE:

1.We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.

2.Please do not exceed the absolute maximum ratings of the device when circuit designing.

3.Winsemi Microelectronics Co., Ltd reserved the right to make changes in this specification sheet and is subject to change without prior notice.

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